

2SC3933

Silicon NPN planer type

For UHF amplification/mixing

Features

- High power gain PG.
- High transition frequency f_T .
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

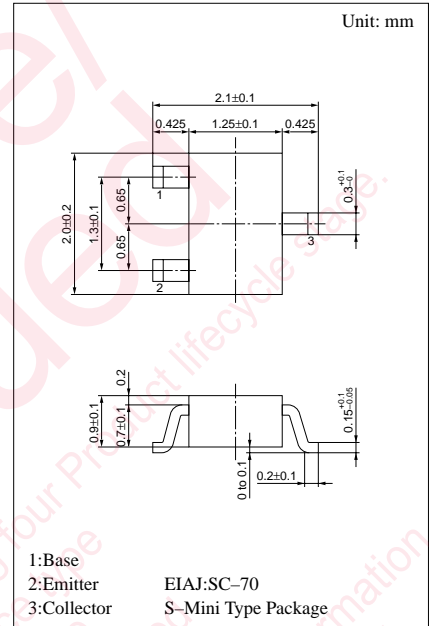
Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
Collector to emitter voltage	V_{CEO}	20	V
Emitter to base voltage	V_{EBO}	3	V
Collector current	I_C	20	mA
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

Electrical Characteristics (Ta=25°C)

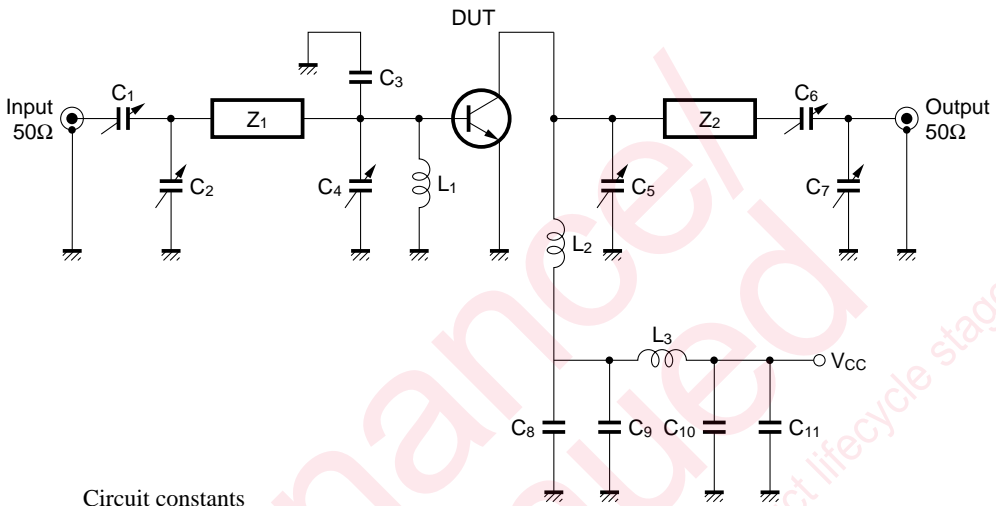
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 25V, I_E = 0$			1	μA
Emitter cutoff current	I_{EBO}	$V_{EB} = 3V, I_C = 0$			10	μA
Forward current transfer ratio	h_{FE1}	$V_{CB} = 10V, I_E = -3mA$	40		200	
	h_{FE2}	$V_{CB} = 10V, I_E = -10mA$	40		200	
	h_{FE3}	$V_{CB} = 10V, I_E = -100\mu A$	60			
Transition frequency	f_T	$V_{CB} = 10V, I_E = -3mA, f = 200MHz$	750	1100	1400	MHz
Collector output capacitance	C_{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		0.7		pF
Common emitter reverse transfer capacitance	C_{rb}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		0.15		pF
Power gain	PG*	$V_{CC} = 11V, V_{AGC} = 3V, f = 800MHz$	14			dB
Noise figure	NF*	$V_{CC} = 11V, V_{AGC} = 3V, f = 800MHz$			5	dB

*PG, NF Refer to the measurement circuit



Marking symbol : 1T

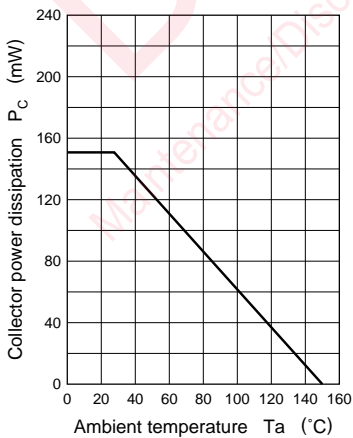
The high-frequency output measurement circuit



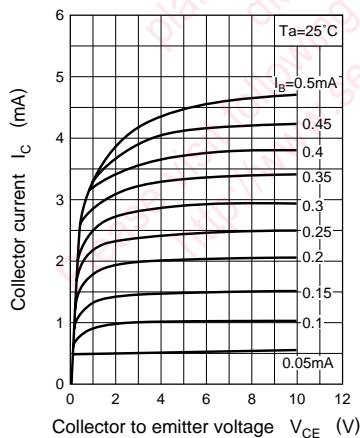
Circuit constants

- C₁, C₂, C₄ ~ C₇ : ~ 20pF
- C₃ : 5pF
- C₈, C₁₀ : 100pF
- C₉, C₁₁ : 1000pF
- L₁, L₂ : φ0.6mm polyurethane, 2T, D = 5
- L₃ : φ0.6mm polyurethane, 2T, D = 5
- Z₁ : copper board, 2.75mm×20mm
- Z₂ : copper board, 2.75mm×20mm

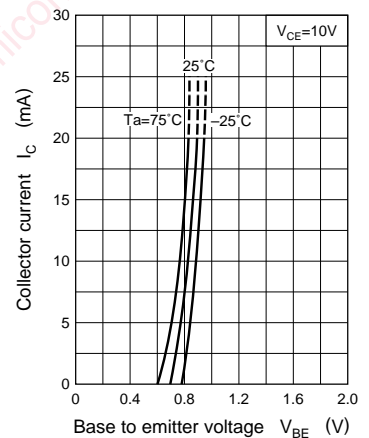
P_C — T_a

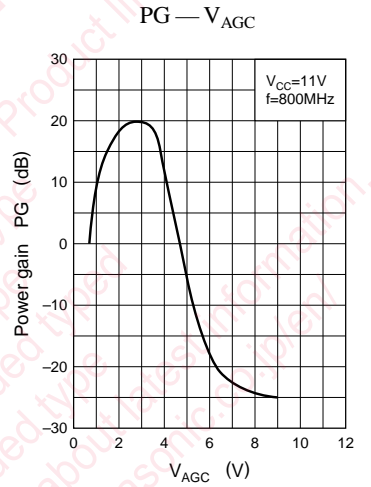
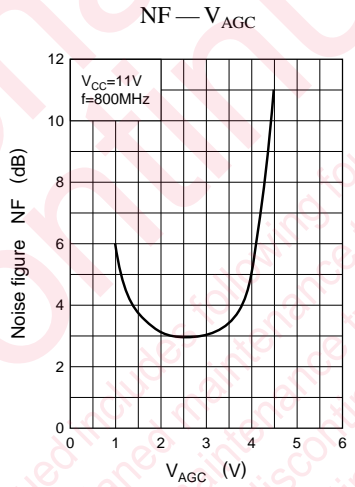
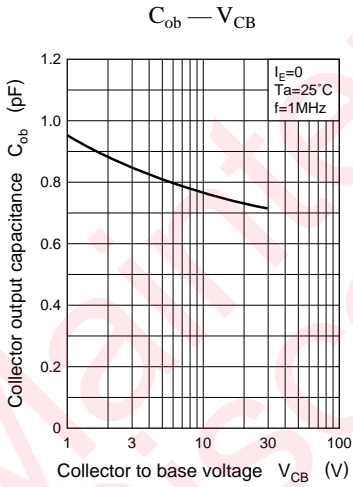
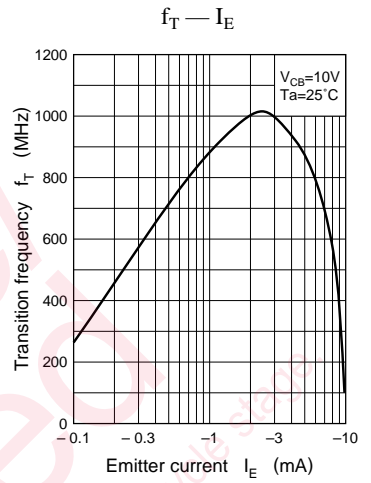
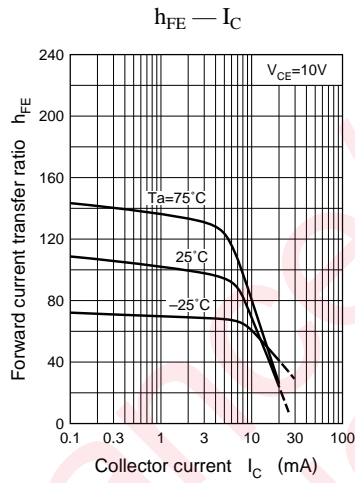
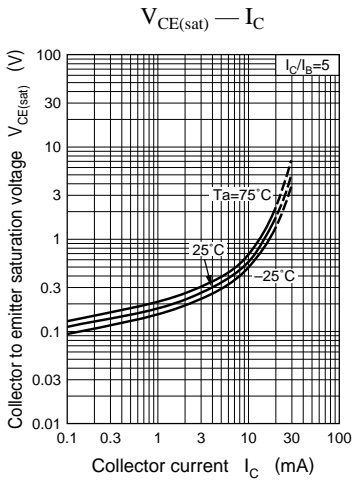


I_C — V_{CE}



I_C — V_{BE}





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